#### TOSHIBA TRANSISTOR SILICON NPN EPITAXIAL PLANAR TYPE

# 2SC2510

### 2~30MHz SSB LINEAR POWER AMPLIFIER APPLICATIONS (28V SUPPLY VOLTAGE USE)

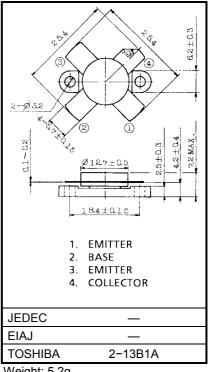
Specified 28V, 28MHz Characteristics

**Output Power**  $: Po = 150W_{PEP} (Min.)$ Power Gain : Gp = 12.2dB (Min.)Collector Efficiency  $\eta_{\rm C} = 35\%$  (Min.) Intermodulation Distortion: IMD = -30 dB (Max.)

### **MAXIMUM RATINGS (Tc = 25°C)**

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	$V_{CBO}$	60	V
Collector-Emitter Voltage	V <sub>CES</sub>	60	V
Collector-Emitter Voltage	V <sub>CEO</sub>	35	٧
Emitter-Base Voltage	V <sub>EBO</sub>	4	٧
Collector Current	I <sub>C</sub>	20	Α
Collector Power Dissipation	P <sub>C</sub>	250	W
Junction Temperature	Tj	175	°C
Storage Temperature Range	T <sub>stg</sub>	-65~175	°C

Unit in mm



Weight: 5.2g

damage to property.

In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..

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## **ELECTRICAL CHARACTERISTICS (Tc = 25°C)**

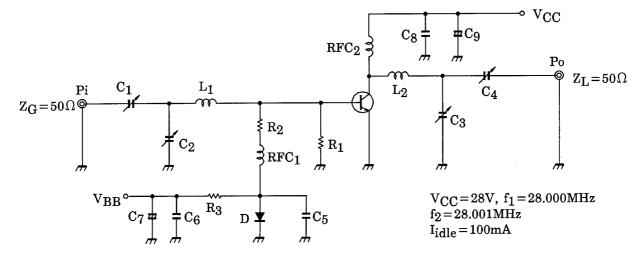
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector-Emitter Breakdown Voltage	V <sub>(BR)</sub> CEO	I <sub>C</sub> = 100mA, I <sub>B</sub> = 0	35	_	_	V
Collector-Emitter Breakdown Voltage	V (BR) CES	I <sub>C</sub> = 100mA, V <sub>EB</sub> = 0	55	_	_	V
Emitter-Base Breakdown Voltage	V (BR) EBO	I <sub>E</sub> = 1mA, I <sub>C</sub> = 0	4	_	_	V
DC Current Gain	h <sub>FE</sub>	V <sub>CE</sub> = 5V, I <sub>C</sub> = 10A *	10	_	_	
Collector Output Capacitance	C <sub>ob</sub>	V <sub>CB</sub> = 28V, I <sub>E</sub> = 0 f = 1MHz	_	450	600	pF
Power Gain	Gp	V <sub>CC</sub> = 28V, f <sub>1</sub> = 28.000MHz, f <sub>2</sub> = 28.001MHz l <sub>idle</sub> = 100mA Po = 150W <sub>PEP</sub> (Fig.)	12.2	13.3	_	dB
Input Power	Pi		_	7	9	W <sub>PEP</sub>
Collector Efficiency	η <sub>C</sub>		35	_	_	%
Intermodulation Distortion	IMD		_	_	-30	dB
Series Equivalent Input Impedance	Z <sub>in</sub>	$V_{CC}$ = 28V, $f_1$ = 28.000MHz, $f_2$ = 28.001MHz, Po = 150W <sub>PEP</sub>	_	1.4 -j0.9	_	Ω
Series Equivalent Output Impedance	Z <sub>out</sub>		-	2.3 -j0.9		Ω

<sup>\*</sup> Pulse Test: Pulse Width ≤ 100µs, Duty Cycle ≤ 3%

### **CAUTION**

Beryllia Ceramics is used in this product. The dust or vapor can be dangerous to humans. Do not break, cut, crush or dissolve chemically. Dispose of this product properly according to law. Do not intermingle with normal industrial or domestic waste.

### Fig. Pi TEST CIRCUIT



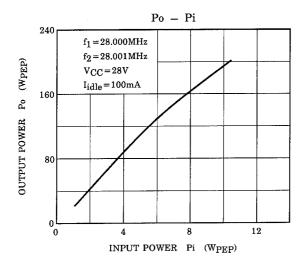
:  $\phi 0.8$  ENAMEL COATED COPPER WIRE, 14ID, 4T, 4P  $C_1$ ,  $C_2$ : 7~150pF  $L_1$ :  $\phi$  1.2 ENAMEL COATED COPPER WIRE, 14ID, 3 1/2T, 3P : 7~150pF 2KWV C3, C4  $_{
m L_2}$ 

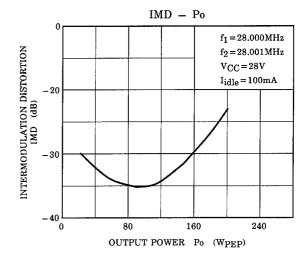
 $\overline{\mathrm{RFC}}_1$ :  $\phi$ 0.8 ENAMEL COATED COPPER WIRE, 10ID, 9T C<sub>5</sub>, C<sub>6</sub> :  $0.022 \mu F$  $C_7$ :  $47 \mu F 10WV$ (Ferrite Core TDK K2)

RFC $_2$ :  $\phi 0.8$  ENAMEL COATED COPPER WIRE, 14ID, 20T :  $0.04 \mu F$ C<sub>8</sub>

:  $10\Omega (1W)$ :  $100 \mu F 50WV$  $R_1$ :  $2\Omega (1/2W)$  $R_2$ :  $10\Omega$  (5W)  $R_3$ 

: 1S1555





### **CAUTION**

These are only typical curves and devices are not necessarily guaranteed at these curves.

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Datasheets for electronics components.